MOSFETs Silicon N-channel MOS (U-MOSX-H)

TPH9R00CQ5

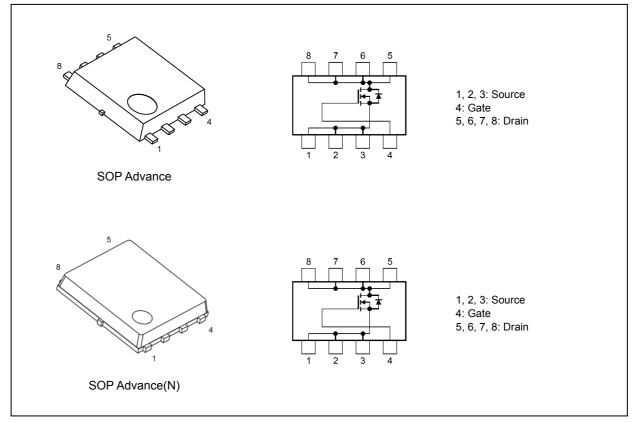
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators
- Motor Drivers

2. Features

- (1) Fast reverse recovery time : t_{rr} = 40 ns (typ.)
- (2) Small reverse recovery charge : $Q_{rr} = 34 \text{ nC}$ (typ.)
- (3) Small gate charge: $Q_{SW} = 11.7 \text{ nC}$ (typ.)
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 7.3 \text{ m}\Omega$ (typ.) (V_{GS} = 10 V)
- (5) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 150 \ V)$
- (6) Enhancement mode: V_{th} = 3.1 to 4.5 V (V_{DS} = 10 V, I_D = 1.0 mA)

3. Packaging and Internal Circuit



The package can be selected according to your preference. For details, please contact your TOSHIBA sales representative.

4. Absolute Maximum Ratings (Note) ($T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characterist	ics		Symbol	Rating	Unit
Drain-source voltage			V _{DSS}	150	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)	(T _c = 25 °C)	(Note 1)	Ι _D	64	A
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	I _D	108	
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I _{DP}	320	
Power dissipation	(T _c = 25 °C)		PD	210	w
Power dissipation		(Note 3)	PD	3	
Power dissipation		(Note 4)	PD	0.96	
Single-pulse avalanche energy		(Note 5)	E _{AS}	139	mJ
Single-pulse avalanche current		(Note 5)	I _{AS}	64	А
Channel temperature			T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This product is not designed for radiation resistance or cosmic ray resistance, and these natural environmental factors may affect reliability. In addition, radiation from the constituent materials of the product also becomes a natural environmental factor, which may affect reliability.

5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)		R _{th(ch-c)}	0.71	°C/W
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 3)	R _{th(ch-a)}	50	
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 4)	R _{th(ch-a)}	156	

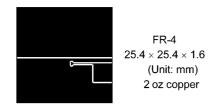
Note 1: Ensure that the channel temperature does not exceed 175 °C.

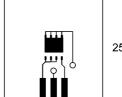
Note 2: Limited by silicon chip capability.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

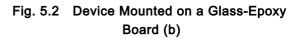
Note 5: V_DD = 60 V, T_ch = 25 °C (initial), L = 47 μ H, I_{AS} = 64 A





FR-4 25.4 × 25.4 × 1.6 (Unit: mm) 2 oz copper

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V	_	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	150	_	—	V
Drain-source breakdown voltage (Note 6)	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	130	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1.0 mA	3.1	_	4.5	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 8 V, I _D = 22 A	_	7.9	11	mΩ
		V _{GS} = 10 V, I _D = 32 A	_	7.3	9.0	

Note 6: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		3500	5400	pF
Reverse transfer capacitance	C _{rss}			19	52	
Output capacitance	C _{oss}			690	_	
Gate resistance	r _g	—	_	1.3	2.0	Ω
Switching time (rise time)	tr	See Figure 6.2.1	_	15	_	ns
Switching time (turn-on time)	t _{on}			32	_	
Switching time (fall time)	t _f			18	_	
Switching time (turn-off time)	t _{off}]	_	41	_	

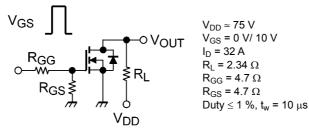


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

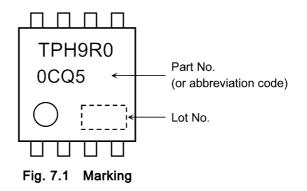
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD}\approx75$ V, V_{GS} = 10 V, I_{D} = 32 A	_	44	_	nC
gate-drain)		$V_{DD} \approx 75$ V, V_{GS} = 8 V, I_D = 22 A	_	36	—	
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 75$ V, V_{GS} = 10 V, I_D = 32 A	_	18	_	
Gate-drain charge	Q _{gd}		_	6.6	_	
Gate switch charge	Q _{SW}		_	11.7		
Output charge	Q _{oss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	_	87	_	

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

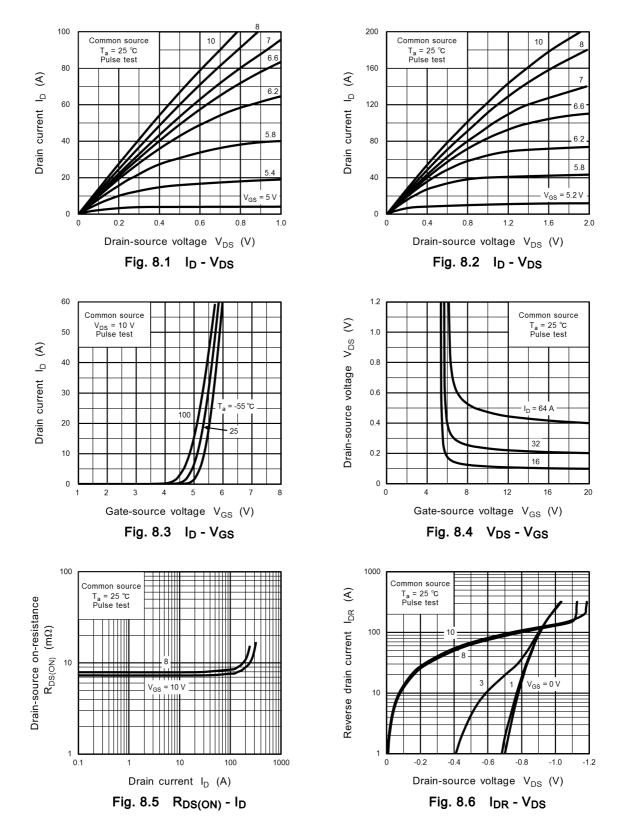
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 7)	I _{DRP}	(t = 100 μs)	_	_	320	A
Diode forward voltage		V _{DSF}	I _{DR} = 32 A, V _{GS} = 0 V	_	_	-1.2	V
Reverse recovery time	(Note 8)	t _{rr}	I _{DR} = 16 A, V _{GS} = 0 V,	_	40	60	ns
Reverse recovery charge	(Note 8)	Q _{rr}	-dI _{DR} /dt = 100 A/μs	—	34	78	nC

Note 7: Ensure that the channel temperature does not exceed 175 °C. Note 8: Defined by design.

7. Marking



8. Characteristics Curves (Note)



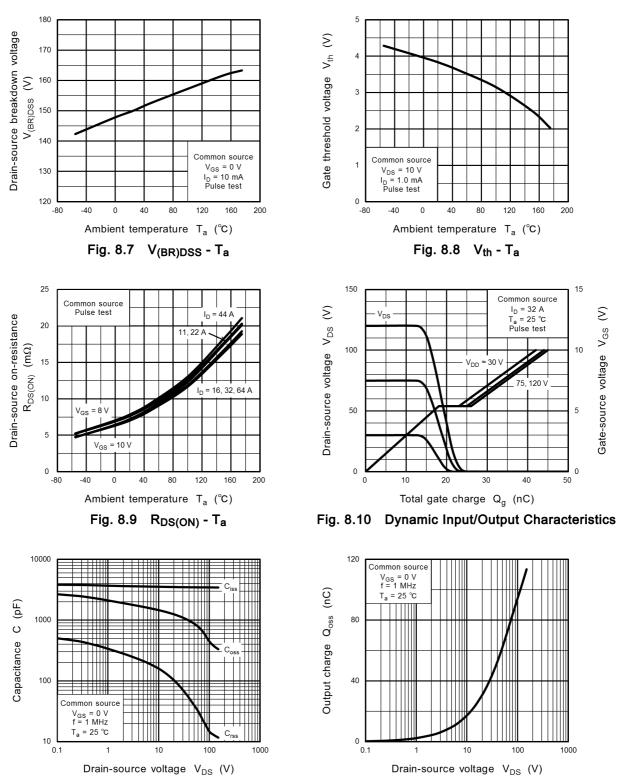
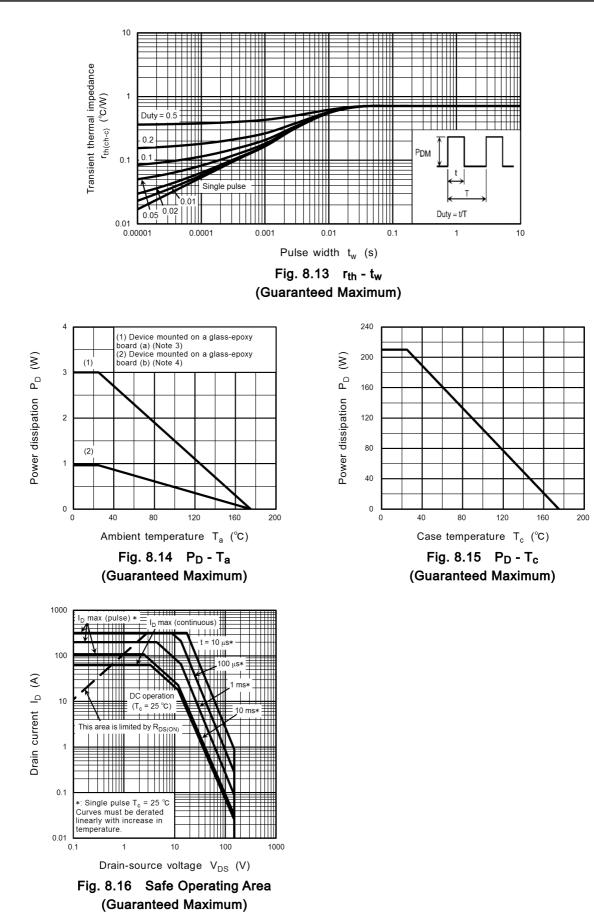
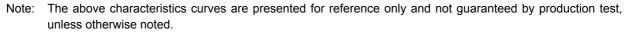


Fig. 8.11 Capacitance - V_{DS}

Fig. 8.12 Q_{oss} - V_{DS}

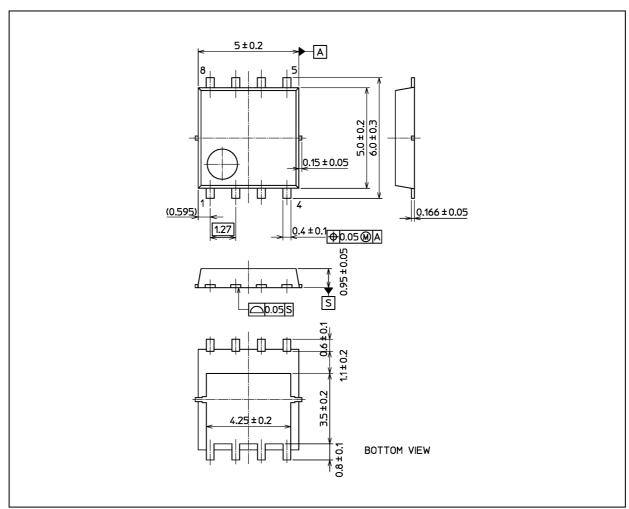




TPH9R00CQ5

Package Dimensions

Unit: mm



The package can be selected according to your preference. For details, please contact your TOSHIBA sales representative.

Weight: 0.087 g (typ.)

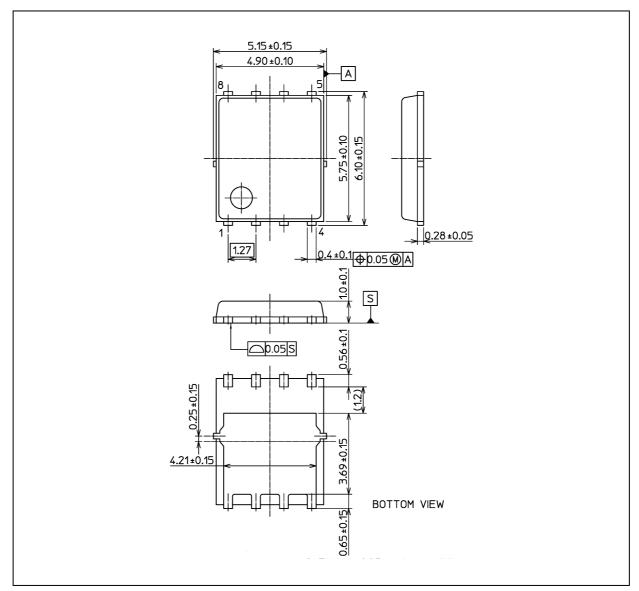
Package Name(s)
TOSHIBA: 2-5Q1S
Nickname: SOP Advance



TPH9R00CQ5

Package Dimensions

Unit: mm



The package can be selected according to your preference. For details, please contact your TOSHIBA sales representative.

Weight: 0.111 g (typ.)

Package Name(s)
TOSHIBA: 2-5W1A
Nickname: SOP Advance(N)

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